#### 501801962 01/30/2012

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Roi Nathan	01/15/2012
Haggai Karlinski	01/15/2012
Gil Fisher	01/26/2012

## RECEIVING PARTY DATA

Name:	HEWLETT-PACKARD INDUSTRIAL LTD.
Street Address:	5c Hatzoran Street
Internal Address:	Netanya Industrial Park
City:	Netanya
State/Country:	ISRAEL
Postal Code:	42505

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12026138

## CORRESPONDENCE DATA

Fax Number: (970)778-4063 Phone: (541)715-8443 Email: terri.tuma@hp.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: Hewlett-Packard Company Address Line 1: 3404 E. Harmony Road MS 35 Address Line 2: Intellectual Property Administration Fort Collins, COLORADO 80528 Address Line 4:

NAME OF SUBMITTER: Montse Druguet

Total Attachments: 3

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> **PATENT** REEL: 027614 FRAME: 0746

HEWLETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: \_\_\_

82221701

# **ASSIGNMENT OF PATENT APPLICATION**

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD INDUSTRIAL PRINTING LTD., having its principal place of business in Netanya, Israel, (hereinafter HPIP), in furtherance of my/our obligations to the Hewlett-Packard Company and its susidiaries and affiliates, and do hereby assign and transfer to HPIP, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

assign and transfer to HPIP, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:	
A METHOD OF INK SUPPLY TO INKJET PRINT HEAD ARRAY	
	ion No.: 12/026138
and the invention(s) and improvement(s) set forth therein, and an (C-I-P's), divisionals, and renewals of and substitutes for said applic Letters Patent of the United States and of countries foreign thereto wany reissues, or reexaminations, or extensions of said Letters Patent.  I/we additionally authorize HPIP to file applications in my/ou held and enjoyed by HPIP, its successors, assigns, nominees or legaterms for which said Letters Patent respectively may be granted, reissame would have been held and enjoyed by me/us had this assignment.	vation for said Letters Patent, and any and all which may be granted thereon or therefore; and in name for Letters Patent in any country, to be all representatives, to the full end of the term or assued or extended, as fully and entirely as the
AND I/we hereby covenant that I/we have full right to convert we have not executed and will not execute any agreement in conflict that I/we will, each time a request is made, and without undue delay, necessary or desirable to perfect the title to said invention(s) or implement, to HPIP, its successors, assigns, nominees or legal represemble, or to its nominee, all known facts respecting said invention(s). Letters Patent, to testify in any legal proceedings, to sign all lawful pacontinuations, C-I-P's, reissue and foreign applications, to make all rido everything possible to aid HPIP, its successors, assigns, nominenforce, for its or their own benefit, proper patent protection for said countries provided the expenses which may be incurred by me/us in paid by HPIP;	with the entire interest herein assigned, and that I/herewith, and I/we further covenant and agree execute and deliver all such papers as may be rovement(s), said application and said Letters entatives, and I/we agree to communicate to or improvement(s), said application and said pers, to execute all disclaimers and divisionals, ghtful oaths and declarations, and generally to nees and legal representatives to obtain and invention(s) or improvement(s) in any and all
AND I/we hereby authorize and request the Commissioner of and any official of any country or countries foreign to the United applications as aforesaid, to issue to HPIP, as assignee of the enti-Patent for said invention(s) or improvement(s), including any and all be issued and granted on or as a result of the application aforesaid, in I/we further authorize and direct the attorneys of record to application now identified by the Record ID and title set forth above	States whose duty it is to issue patents on ire right, title and interest, any and all Letters Letters Patent of the United States which may accordance with the terms of this assignment. insert the serial number and filing date of said
known to them by the United States Patent and Trademark Office.	
Rai Nathan	15/1/2012
Inventor's Signature	Date Assignment algred
Roi Nathan Inventor's Typed Name	April, 2nd 2008  Date Application Signed
Inventor's Signature	Date Assignment Signed
- Haggai Karlinski	March 23rd 2008
Inventor's Typed Name	Date Application Signed
<del></del>	-

Page 1 of 2

HEVA ETT-PACKARD COMPANY Intellectual Property Administrator 3404 E. Hannony Road Mail Stop 35 Fort Collins, Colorado 80528

PATENT APPLICATION

record id:	82221701

## **ASSIGNMENT OF PATENT APPLICATION**

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD INDUSTRIAL PRINTING LTD., having its principal place of business in Netanya, Israel, (hereinafter HPIP), in furtherance of my/our obligations to the Hewlett-Packard Company and its susidiaries and affiliates, and do hereby assign and transfer to HPIP, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

assign and transfer to HPIP, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:  A METHOD OF INK SUPPLY TO INKJET PRINT HEAD ARRAY	
Filing Date: Feb 05, 2008  and the invention(s) and improvement(s) set forth their (C-I-P's), divisionals, and renewals of and substitutes for Letters Patent of the United States and of countries foreig any reissues, or reexaminations, or extensions of said Let Vive additionally authorize HPIP to file application held and enjoyed by HPIP, its successors, assigns, nominaterms for which said Letters Patent respectively may be same would have been held and enjoyed by me/us had the AND live hereby covenant that live have fulling we have not executed and will not execute any agreement that live will, each time a request is made, and without unnecessary or desirable to perfect the title to said invention Patent, to HPIP, its successors, assigns, nominees or HPIP, or to its nominee, all known facts respecting said Letters Patent, to testify in any legal proceedings, to sign continuations, C-I-P's, reissue and foreign applications, to do everything possible to aid HPIP, its successors, assenforce, for its or their own benefit, proper patent protect countries provided the expenses which may be incurred paid by HPIP;  AND live hereby authorize and request the Comand any official of any country or countries foreign to applications as aforesaid, to issue to HPIP, as assigned Patent for said invention(s) or improvement(s), including be issued and granted on or as a result of the application.	Application No.: 12/026138  rein, and any and all continuations, continuations-in-part read application for said Letters Patent, and any and all gn thereto which may be granted thereon or therefore; and ters Patent, ins in my/our name for Letters Patent in any country, to be nees or legal representatives, to the full end of the term or granted, reissued or extended, as fully and entirely as the is assignment, and transfer not been made; int to convey the entire interest herein assigned, and that to int in conflict herewith, and I/we further covenant and agree indue delay, execute and deliver all such papers as may be on(s) or improvement(s), said application and said Letters legal representatives, and I/we agree to communicate to invention(s) or improvement(s), said application and said all lawful papers, to execute all disclaimers and divisionals, or make all rightful oaths and declarations, and generally to signs, nominees and legal representatives to obtain and tion for said invention(s) or improvement(s) in any and all by me/us in lending such cooperation and assistance are imissioner of Patents and Trademarks of the United States the United States whose duty it is to issue patents on the United States whose duty it is to issue patents on to of the entire right, title and interest, any and all Letters any and all Letters Patent of the United States which may aforesaid, in accordance with the terms of this assignment, of record to insert the serial number and filing date of said forth above as soon as the same shall have been made
Inventor's Signature	Date Assignment Signed
Roi Nathan	April, 2nd 2008
Inventors Typed Name	Date Application Signed  IS 1 2012
Inventor's Signature	Date Assignment Signed
Haggei Kadinski	March 23rd 2008

Rev 09/11 (MPIP-Soits» Assignment)

Page 1 of 2

HEWLETT-PACKARD COMPANY
Intellectual Property Administrator
3404 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

## PATENT APPLICATION

Mail Stop 35 Fort Collins, Colorade 80528	RECORD ID: 82221701	
	SSIGNMENT OF PATENT APPLICATION (cont.)	
	26/1/2012	
Inventor's Signature	Date Assignment Signed	
Gil Fisher	March 6th 2008  Date Application Signed	
nventor's Typed Name	Partie Administration Comments	
Inventor's Signature	Date Assignment Signed	
Inventor's Typed Name	Date Application Signed	
inventor's Signature	Date Assignment Signed	
inventor's Typed Name	Date Application Signed	
Inventor's Signature	Date Assignment Signed	
Inventor's Typed Name	Date Application Signed	
Inventor's Signature	Date Assignment Signed	
Inventor's Typed Name	Date Application Signed	
Inventor's Signature	Date Assignment Signed	
Inventor's Typed Name	Date Application Signed	

Rev 09/11 (HPIP-Solex Assignment)

Page 2 of 2

PATENT REEL: 027614 FRAME: 0749